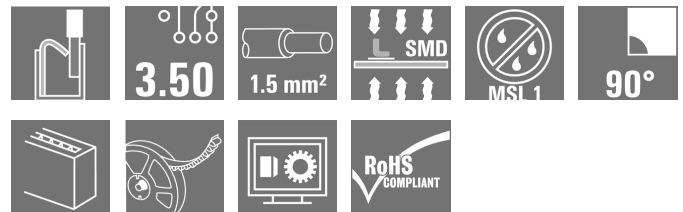


OMNIMATE Signal - series LSF LSF-SMD 3.50/03/90 SN BK RL

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 16
D-32758 Detmold
Germany
Fon: +49 5231 14-0
Fax: +49 5231 14-292083
www.weidmueller.com



The innovative quick connector - simple, safe and economical:

PCB terminals with spring connection and direct PUSH IN technology. A milestone in connection technology.

Amazingly simple and simply amazing in practice:

- Connect and easily detach solid wires or wires with wire-end ferrules without using tools
- Processed automatically in the reflow or vapour phase
- Potentials and clamping points marked clearly by coloured push buttons

World-class design-in and processing phases, and suitable for a vast range of applications.

PCB terminal for fully automatic assembly using reflow soldering (SMD), with PUSH IN wire connections. Conductor insertion and slider operation from the same direction (TOP).

- **Solid & flexible conductors with wire-end ferrules need only to be inserted and they are ready.**
- **When connecting stranded wires without wire-end ferrules the actuating element is used to open the terminal point**
- **Intuitive handling – since the wire-entry area and handling area are clearly separated.**
- **Packaged in tape-on-reel**
- **Conductor outlet direction 90°**

General ordering data

Type	LSF-SMD 3.50/03/90 SN BK RL
Order No.	1412420000
Version	PCB terminal, 3.50 mm, No. of poles: 3, 90°, Black, PUSH IN, Clamping range, max.: 1.5 mm², Tape (Ø 330 mm); $R_s = 10^9 - 10^{12} \Omega$
GTIN (EAN)	4050118214055
Qty.	320 pc(s).
Product data	IEC: 320 V / 17.5 A / 0.2 - 1.5 mm² UL: 300 V / 12 A / AWG 24 - AWG 16
Packaging	Tape (Ø 330 mm); $R_s = 10^9 - 10^{12} \Omega$

OMNIMATE Signal - series LSF

LSF-SMD 3.50/03/90 SN BK RL

Weidmüller Interface GmbH & Co. KG
 Klingenbergstraße 16
 D-32758 Detmold
 Germany
 Fon: +49 5231 14-0
 Fax: +49 5231 14-292083
 www.weidmueller.com

Technical data

Dimensions and weights

Net weight	2.78 g
------------	--------

System parameters

Product family	OMNIMATE Signal - series LSF	Wire connection method	PUSH IN
Mounting onto the PCB	SMD solder connection	Conductor outlet direction	90°
Pitch in mm (P)	3.5 mm	Pitch in inches (P)	0.138 inch
No. of poles	3	Fitted by customer	No
Coplanarity:	100 µm	Number of solder pins per pole	2
Stripping length	8 mm	L1 in mm	7 mm
L1 in inches	0.276 inch	Touch-safe protection acc. to DIN VDE 0470	IP 20
Touch-safe protection acc. to DIN VDE 57 106	Safe from finger touch	Volume resistance	1.60 mΩ

Material data

Insulating material	LCP GF	Colour	Black
Colour chart (similar)	RAL 9011	Insulating material group	IIIa
CTI	≥ 175	Insulation resistance	≥ 10 ⁸ Ω
Moisture Level (MSL)	1	UL 94 flammability rating	V-0
Contact material	Copper alloy	Layer structure of solder connection	4-6 µm Sn matt
Storage temperature, min.	-25 °C	Storage temperature, max.	55 °C
Max. relative humidity during storage	80 %	Operating temperature, min.	-50 °C
Operating temperature, max.	120 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	120 °C		

Conductors suitable for connection

Clamping range, min.	0.13 mm ²	Clamping range, max.	1.5 mm ²
Wire connection cross section AWG, min.	AWG 24	Wire connection cross section AWG, max.	AWG 16
Solid, min. H05(07) V-U	0.2 mm ²	Solid, max. H05(07) V-U	1.5 mm ²
Flexible, min. H05(07) V-K	0.2 mm ²	Flexible, max. H05(07) V-K	1.5 mm ²
w. plastic collar ferrule, DIN 46228 pt 4, min.	0.25 mm ²	w. plastic collar ferrule, DIN 46228 pt 4, max.	0.75 mm ²
w. wire end ferrule, DIN 46228 pt 1, min.	0.25 mm ²	w. wire end ferrule, DIN 46228 pt 1, max.	1.5 mm ²

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. no. of poles (Tu=20°C)	17.5 A
Rated current, max. no. of poles (Tu=20°C)	16 A	Rated current, min. no. of poles (Tu=40°C)	17.5 A
Rated current, max. no. of poles (Tu=40°C)	14 A	Rated voltage for surge voltage class / pollution degree II/2	320 V
Rated voltage for surge voltage class / pollution degree III/2	160 V	Rated voltage for surge voltage class / pollution degree III/3	160 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	2.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	2.5 kV	Short-time withstand current resistance	3 x 1s with 80 A

OMNIMATE Signal - series LSF
LSF-SMD 3.50/03/90 SN BK RL

Weidmüller Interface GmbH & Co. KG
 Klingenbergstraße 16
 D-32758 Detmold
 Germany
 Fon: +49 5231 14-0
 Fax: +49 5231 14-292083
 www.weidmueller.com

Technical data
Rated data acc. to CSA

Rated voltage (Use group B)	300 V	Rated voltage (use group D)	300 V
Rated current (use group B)	10 A	Rated current (use group D)	10 A
Wire cross-section, AWG, min.	AWG 24	Wire cross-section, AWG, max.	AWG 16

Rated data acc. to UL 1059

Institute (cURus)		Certificate No. (cURus)	E60693
Rated voltage (use group B)	300 V	Rated voltage (use group D)	300 V
Rated current (use group B)	12 A	Rated current (use group D)	10 A
Wire cross-section, AWG, min.	AWG 24	Wire cross-section, AWG, max.	AWG 16
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

Classifications

ETIM 3.0	EC001284	ETIM 4.0	EC002643
ETIM 5.0	EC002643	ETIM 6.0	EC002643
eClass 6.2	27-26-11-01	eClass 7.1	27-44-04-01
eClass 8.1	27-44-04-01	eClass 9.0	27-44-04-01
eClass 9.1	27-44-04-01		

Notes

Notes	• Additional push button colours on request • Operating force of slider max. 40 N • Rated current related to rated cross-section & min. No. of poles. • Wire end ferrule with plastic collar to DIN 46228/4 • Wire end ferrule without plastic collar to DIN 46228/1 • P on drawing = pitch • Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards. • Crimping shape "A" for wire end ferrules with PZ 6/5 crimping tool are recommended for the largest cable sizes.
IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.

Approvals

Approvals	
ROHS	Conform

Creation date July 2, 2018 10:02:51 AM CEST

OMNIMATE Signal - series LSF LSF-SMD 3.50/03/90 SN BK RL

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 16
D-32758 Detmold
Germany
Fon: +49 5231 14-0
Fax: +49 5231 14-292083
www.weidmueller.com

Technical data

Downloads

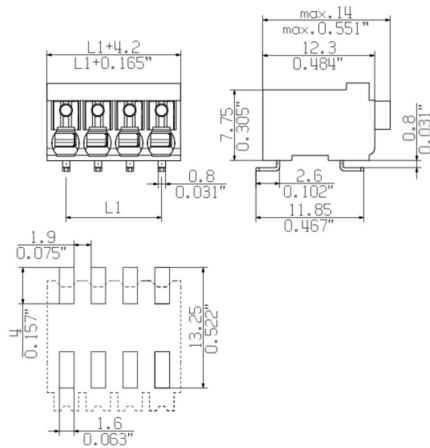
Approval/Certificate/Document of Conformity	Declaration of the Manufacturer
Brochure/Catalogue	FL DRIVES EN PI OMNIMATE LSF SMD EN FL ANALO.SIGN.CONV. EN MB DEVICE MANUF. EN FL DRIVES DE FL BUILDING SAFETY EN FL APPL LED LIGHTING EN FL INDUSTR.CONTROLS EN FL MACHINE SAFETY EN FL HEATING ELECTR EN FL APPL INVERTER EN FL_BASE_STATION_EN FL ELEVATOR EN FL POWER SUPPLY EN FL 72H SAMPLE SER EN PO OMNIMATE EN
Engineering Data	EPLAN, WSCAD
Engineering Data	STEP
SMT white paper	Download Whitepaper

OMNIMATE Signal - series LSF LSF-SMD 3.50/03/90 SN BK RL

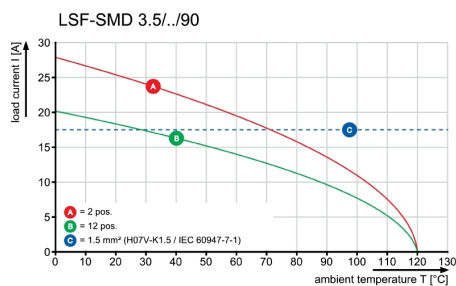
Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 16
D-32758 Detmold
Germany
Fon: +49 5231 14-0
Fax: +49 5231 14-292083
www.weidmueller.com

Drawings

Dimensional drawing



Graph

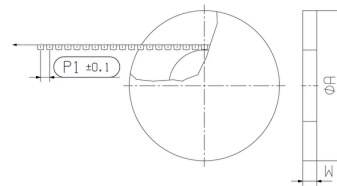


OMNIMATE Signal - series LSF LSF-SMD 3.50/03/90 SN BK RL

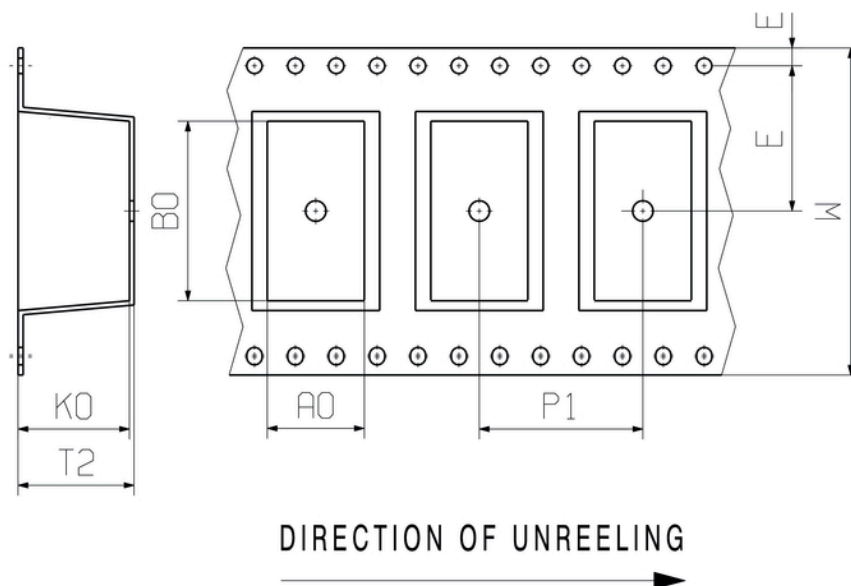
Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 16
D-32758 Detmold
Germany
Fon: +49 5231 14-0
Fax: +49 5231 14-292083
www.weidmueller.com

Drawings

Dimensional drawing

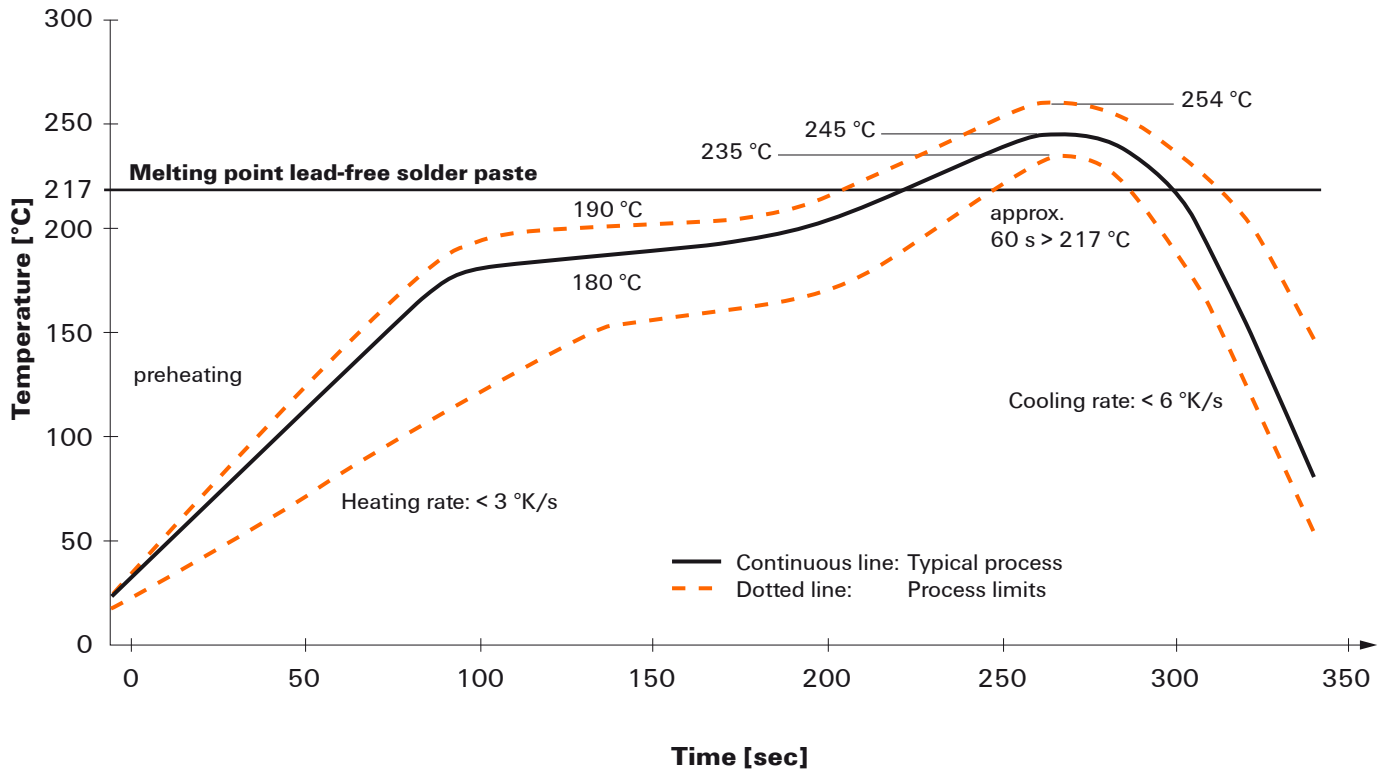


Dimensional drawing



Recommended reflow soldering profile

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 16
D-32758 Detmold
Germany
Fon: +49 5231 14-0
Fax: +49 5231 14-292083
www.weidmueller.com



Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.